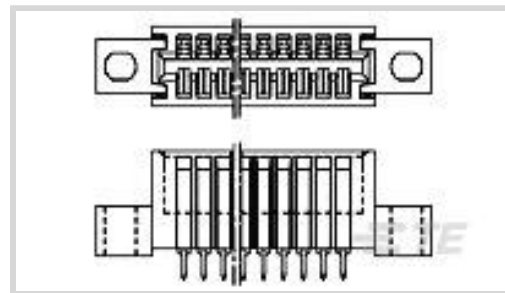




Connectors > PCB Connectors > Card Edge Connectors > Standard Edge Connectors



Connector System: **Board-to-Board**

Number of Positions: **18**

Centerline (Pitch): **3.96 mm [.156 in]**

Number of Rows: **1**

Housing Color: **Green**

Features

Product Type Features

Connector System	Board-to-Board
Connector & Housing Type	Receptacle
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Positions	18
Number of Rows	1
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical

Body Features

Connector Profile	Low
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Contact Features

Contact Retention Within Housing	Without
PCB Contact Termination Area Plating Material Thickness	3 μm
Contact Type	Socket
Contact Mating Area Plating Material Thickness	3 μm[118.11 μin]
Contact Mating Area Plating Material	Tin
Contact Base Material	Phosphor Bronze

Termination Features

Termination Post & Tail Length	3.2 mm[.13 in]
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Termination Method to Printed Circuit Board

Through Hole - Solder

Mechanical Attachment

Mating Alignment Type	Polarization
Mating Retention	Without
Mating Alignment	With
PCB Mount Alignment	Without
Panel Mount Feature	Without
PCB Mount Retention	With
Panel Mount Feature Type	Mounting Ears
PCB Mount Retention Type	Mounting Ears

Housing Features

Centerline (Pitch)	3.96 mm[.156 in]
Housing Color	Green
Housing Material	Polyester - GF

Dimensions

Card Slot Depth	8.5 mm[.33 in]
Connector Height	13.4 mm[.53 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]

Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Method	Tube
Packaging Quantity	6

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUN 2016 (169) Does not contain REACH SVHC

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Documents

CAD Files

Customer View Model

[ENG_CVM_CVM_1-167251-8_G.2d_dxf.zip](#)

English

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_1-167251-8_G.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1-167251-8_G.3d_stp.zip](#)

English

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